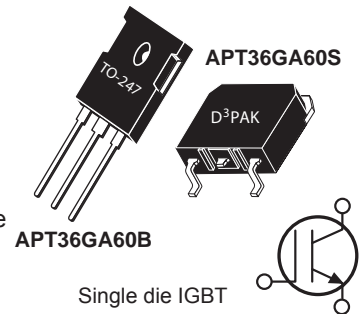


## High Speed PT IGBT

POWER MOS 8® is a high speed Punch-Through switch-mode IGBT. Low  $E_{off}$  is achieved through leading technology silicon design and lifetime control processes. A reduced  $E_{off} - V_{CE(ON)}$  tradeoff results in superior efficiency compared to other IGBT technologies. Low gate charge and a greatly reduced ratio of  $C_{res}/C_{ies}$  provide excellent noise immunity, short delay times and simple gate drive. The intrinsic chip gate resistance and capacitance of the poly-silicone gate structure help control di/dt during switching, resulting in low EMI, even when switching at high frequency.



### FEATURES

- Fast switching with low EMI
- Very Low  $E_{off}$  for maximum efficiency
- Ultra low  $C_{res}$  for improved noise immunity
- Low conduction loss
- Low gate charge
- Increased intrinsic gate resistance for low EMI
- RoHS compliant

### TYPICAL APPLICATIONS

- ZVS phase shifted and other full bridge
- Half bridge
- High power PFC boost
- Welding
- UPS, solar, and other inverters
- High frequency, high efficiency industrial

### Absolute Maximum Ratings

| Symbol         | Parameter   | Ratings     | Unit |
|----------------|---|-------------|------|
| $V_{ces}$      | Collector Emitter Voltage                                       | 600         | V    |
| $I_{C1}$       | Continuous Collector Current @ $T_c = 25^\circ\text{C}$         | 65          | A    |
| $I_{C2}$       | Continuous Collector Current @ $T_c = 100^\circ\text{C}$        | 36          |      |
| $I_{CM}$       | Pulsed Collector Current <sup>1</sup>                           | 109         |      |
| $V_{GE}$       | Gate-Emitter Voltage <sup>2</sup>                               | ±30         | V    |
| $P_D$          | Total Power Dissipation @ $T_c = 25^\circ\text{C}$              | 290         | W    |
| SSOA           | Switching Safe Operating Area @ $T_j = 150^\circ\text{C}$       | 109A @ 600V |      |
| $T_J, T_{STG}$ | Operating and Storage Junction Temperature Range                | -55 to 150  | °C   |
| $T_L$          | Lead Temperature for Soldering: 0.063" from Case for 10 Seconds | 300         |      |

### Static Characteristics

$T_J = 25^\circ\text{C}$  unless otherwise specified

| Symbol        | Parameter                           | Test Conditions              | Min | Typ | Max  | Unit |
|---------------|-------------------------------------|------------------------------|-----|-----|------|------|
| $V_{BR(CEs)}$ | Collector-Emitter Breakdown Voltage | $V_{GE} = 0V, I_C = 1.0mA$   | 600 |     |      | V    |
| $V_{CE(on)}$  | Collector-Emitter On Voltage        | $V_{GE} = 15V, I_C = 20A$    |     | 2.0 | 2.5  |      |
| $V_{GE(th)}$  | Gate Emitter Threshold Voltage      | $V_{GE} = V_{CE}, I_C = 1mA$ | 3   | 4.5 | 6    |      |
| $I_{CES}$     | Zero Gate Voltage Collector Current | $V_{CE} = 600V, V_{GE} = 0V$ |     |     | 250  | µA   |
| $I_{GES}$     | Gate-Emitter Leakage Current        | $V_{GS} = \pm 30V$           |     |     | ±100 |      |

### Thermal and Mechanical Characteristics

| Symbol          | Characteristic                                     | Min | Typ | Max  | Unit   |
|-----------------|--|-----|-----|------|--------|
| $R_{\theta JC}$ | Junction to Case Thermal Resistance                | -   | -   | 0.43 | °C/W   |
| $W_T$           | Package Weight                                     | -   | 5.9 | -    | g      |
| Torque          | Mounting Torque (TO-247 Package), 4-40 or M3 screw |     |     | 10   | in-lbf |

Dynamic Characteristics

T<sub>J</sub> = 25°C unless otherwise specified

APT36GA60B

| Symbol                        | Parameter                     | Test Conditions  | Min | Typ  | Max | Unit |
|-------------------------------|-------------------------------|--|-----|------|-----|------|
| C <sub>ies</sub>              | Input Capacitance             | Capacitance<br>V <sub>GE</sub> = 0V, V <sub>CE</sub> = 25V<br>f = 1MHz   |     | 2880 |     | pF   |
| C <sub>oes</sub>              | Output Capacitance            |  |     | 226  |     |      |
| C <sub>res</sub>              | Reverse Transfer Capacitance  |  |     | 328  |     |      |
| Q <sub>g</sub>                | Total Gate Charge             | Gate Charge<br>V <sub>GE</sub> = 15V<br>V <sub>CE</sub> = 300V<br>I <sub>C</sub> = 20A   |     | 102  |     | nC   |
| Q <sub>ge</sub>               | Gate-Emitter Charge           |  |     | 18   |     |      |
| Q <sub>gc</sub>               | Gate- Collector Charge        |  |     | 34   |     |      |
| SSOA                          | Switching Safe Operating Area | T <sub>J</sub> = 150°C, R <sub>G</sub> = 10Ω <sup>4</sup> , V <sub>GE</sub> = 15V,<br>L = 100uH, V <sub>CE</sub> = 600V  | 109 |      |     | A    |
| t <sub>d(on)</sub>            | Turn-On Delay Time            | Inductive Switching (25°C)<br>V <sub>CC</sub> = 400V<br>V <sub>GE</sub> = 15V<br>I <sub>C</sub> = 20A<br>R <sub>G</sub> = 10Ω <sup>4</sup><br>T <sub>J</sub> = +25°C   |     | 16   |     | ns   |
| t <sub>r</sub>                | Current Rise Time             |  |     | 14   |     |      |
| t <sub>d(off)</sub>           | Turn-Off Delay Time           |  |     | 122  |     |      |
| t <sub>f</sub>                | Current Fall Time             |  |     | 77   |     |      |
| E <sub>on2</sub>              | Turn-On Switching Energy      | Inductive Switching (125°C)<br>V <sub>CC</sub> = 400V<br>V <sub>GE</sub> = 15V<br>I <sub>C</sub> = 20A<br>R <sub>G</sub> = 10Ω <sup>4</sup><br>T <sub>J</sub> = +125°C |     | 307  |     | μJ   |
| E <sub>off</sub> <sup>6</sup> | Turn-Off Switching Energy     |  |     | 254  |     |      |
| t <sub>d(on)</sub>            | Turn-On Delay Time            |  |     | 14   |     | ns   |
| t <sub>r</sub>                | Current Rise Time             |  |     | 15   |     |      |
| t <sub>d(off)</sub>           | Turn-Off Delay Time           |  |     | 149  |     |      |
| t <sub>f</sub>                | Current Fall Time             |  |     | 113  |     |      |
| E <sub>on2</sub>              | Turn-On Switching Energy      |  | 508 |      | μJ  |      |
| E <sub>off</sub> <sup>6</sup> | Turn-Off Switching Energy     |  | 439 |      |     |      |

1 Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.

2 Pulse test: Pulse Width < 380μs, duty cycle < 2%.

3 See Mil-Std-750 Method 3471

4 R<sub>G</sub> is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)

5 E<sub>on2</sub> is the clamped inductive turn on energy that includes a commutating diode reverse recovery current in the IGBT turn on energy loss. A combi device is used for the clamping diode.

6 E<sub>off</sub> is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1.

**Microsemi reserves the right to change, without notice, the specifications and information contained herein.**

Typical Performance Curves

APT36GA60B\_S

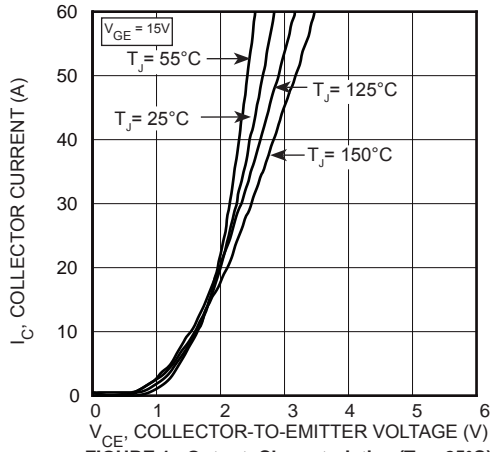


FIGURE 1, Output Characteristics ( $T_J = 25^\circ\text{C}$ )

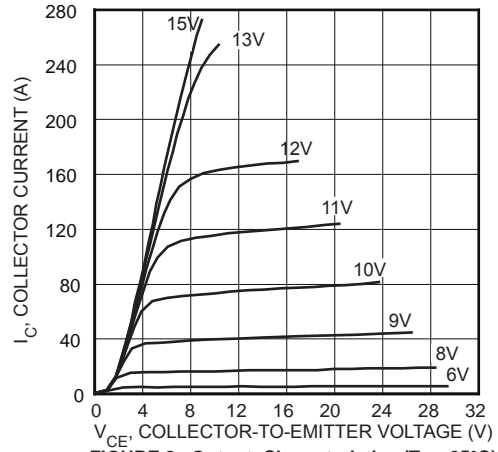


FIGURE 2, Output Characteristics ( $T_J = 25^\circ\text{C}$ )

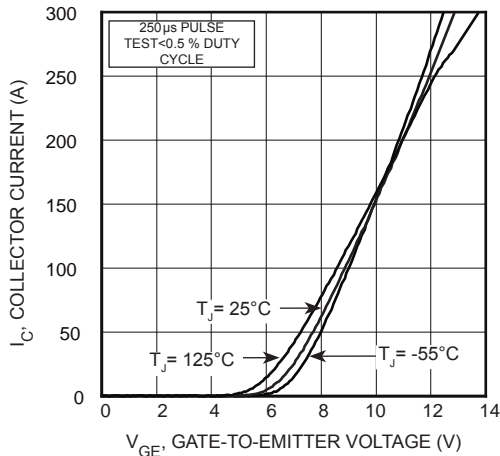


FIGURE 3, Transfer Characteristics

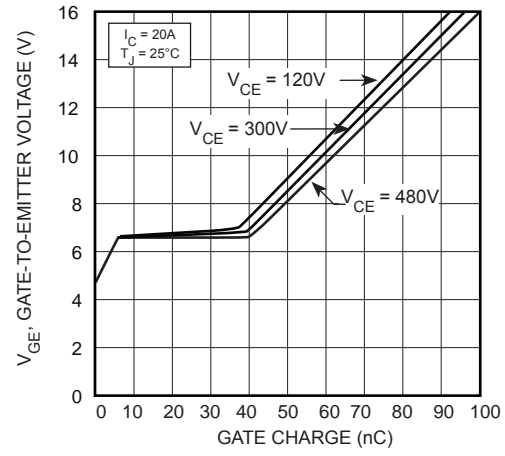


FIGURE 4, Gate charge

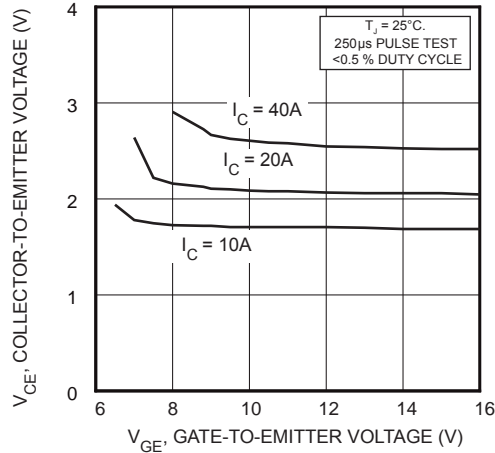


FIGURE 5, On State Voltage vs Gate-to-Emitter Voltage

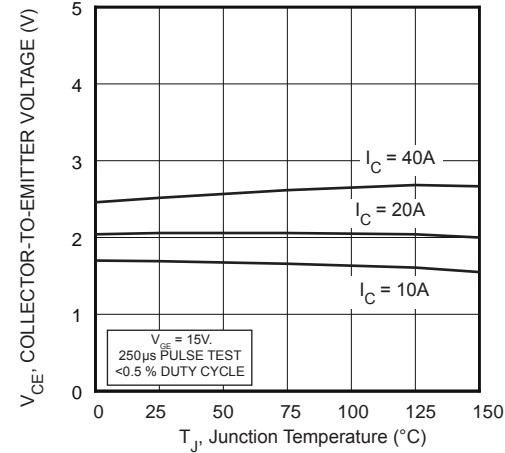


FIGURE 6, On State Voltage vs Junction Temperature

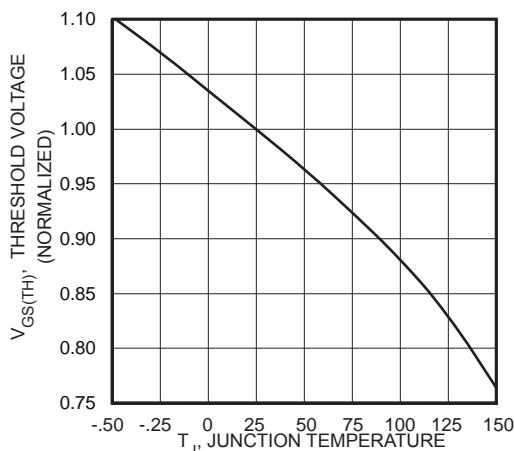


FIGURE 7, Threshold Voltage vs Junction Temperature

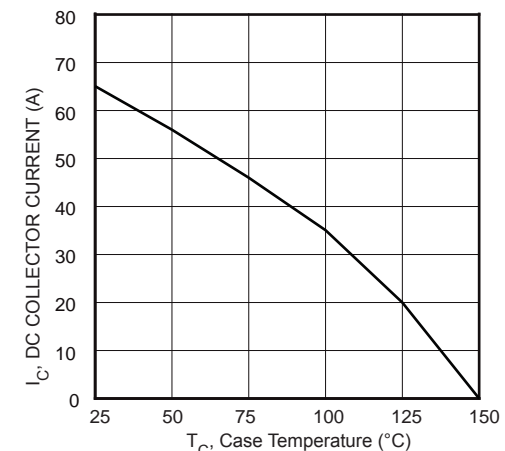


FIGURE 8, DC Collector Current vs Case Temperature

# Typical Performance Curves

APT36GA60B\_S

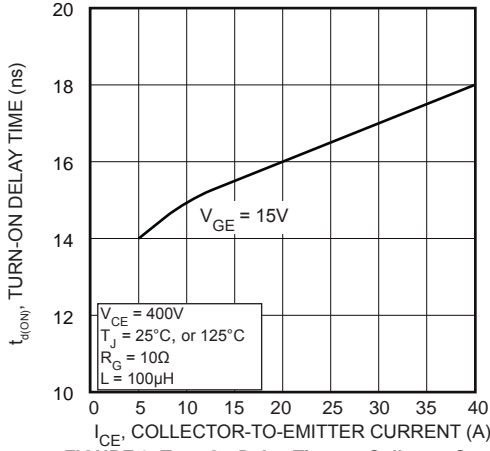


FIGURE 9, Turn-On Delay Time vs Collector Current

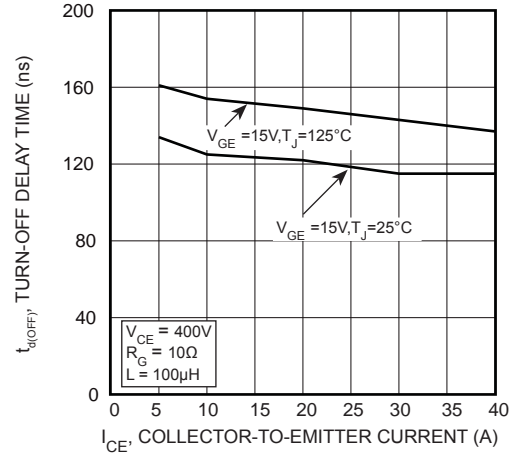


FIGURE 10, Turn-Off Delay Time vs Collector Current

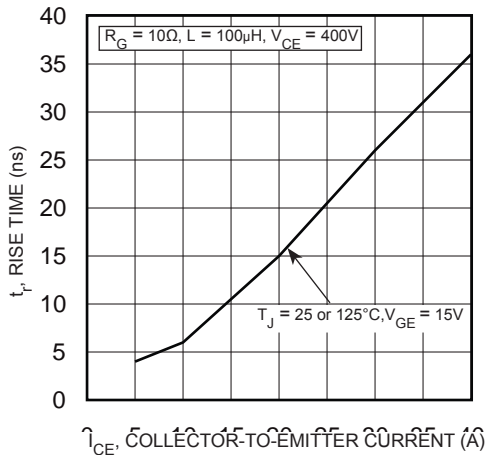


FIGURE 11, Current Rise Time vs Collector Current

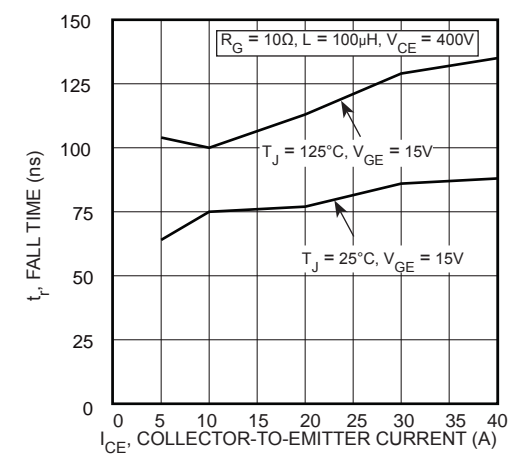


FIGURE 12, Current Fall Time vs Collector Current

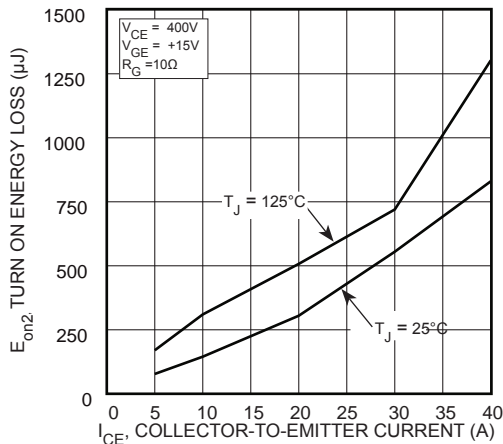


FIGURE 13, Turn-On Energy Loss vs Collector Current

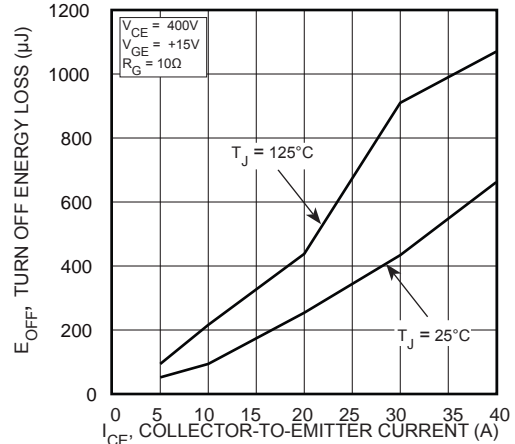


FIGURE 14, Turn-Off Energy Loss vs Collector Current

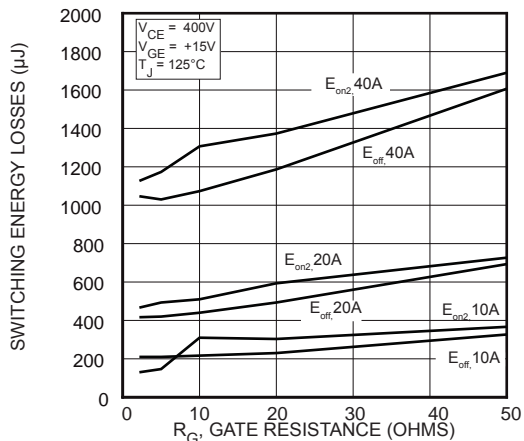


FIGURE 15, Switching Energy Losses vs Gate Resistance

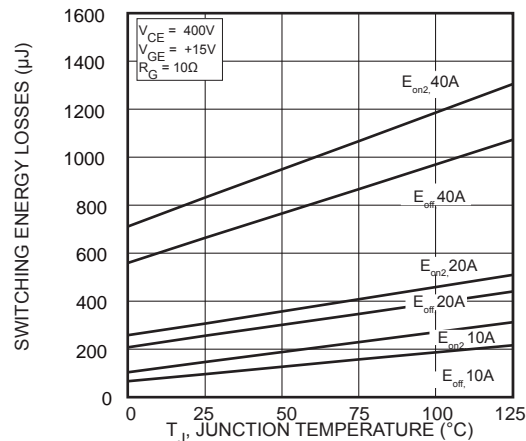


FIGURE 16, Switching Energy Losses vs Junction Temperature

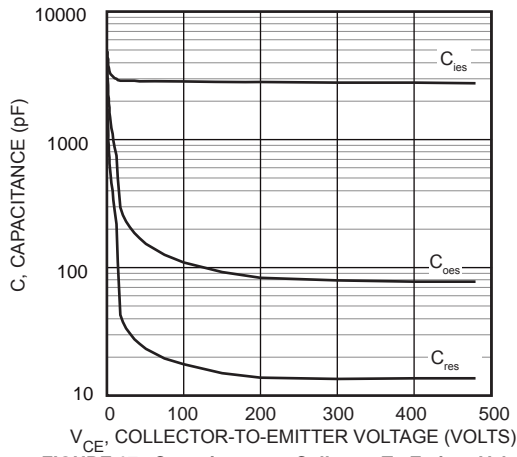


FIGURE 17, Capacitance vs Collector-To-Emitter Voltage

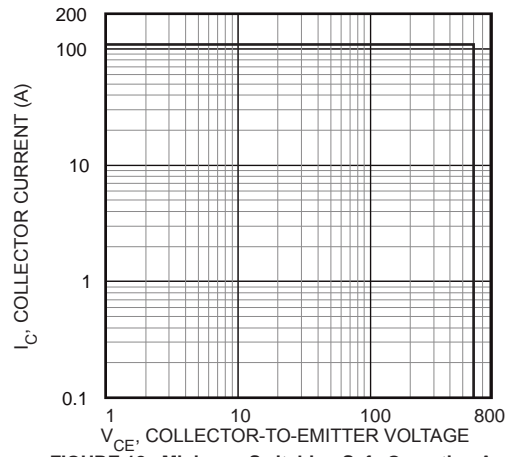


FIGURE 18, Minimum Switching Safe Operating Area

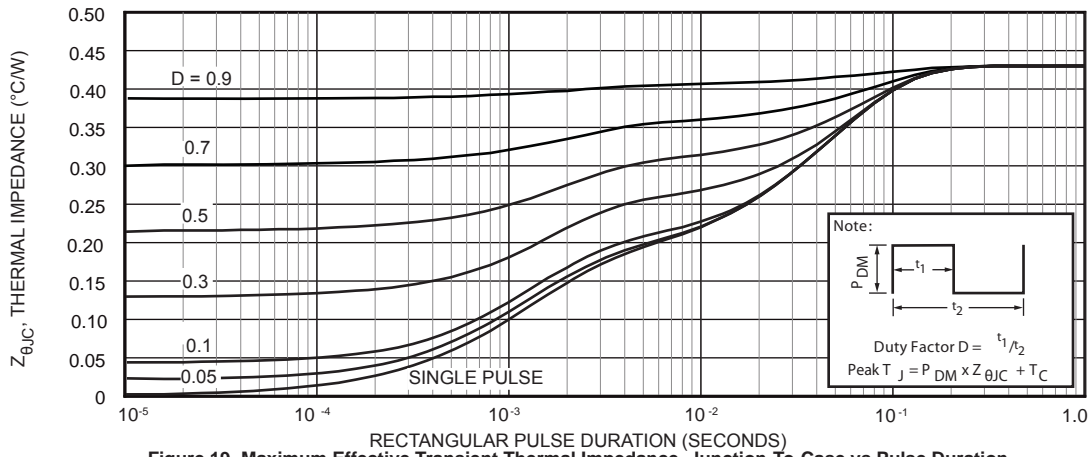


Figure 19, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration

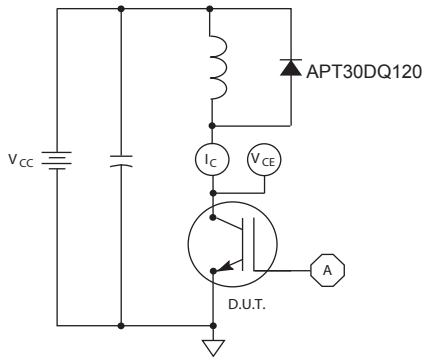


Figure 20, Inductive Switching Test Circuit

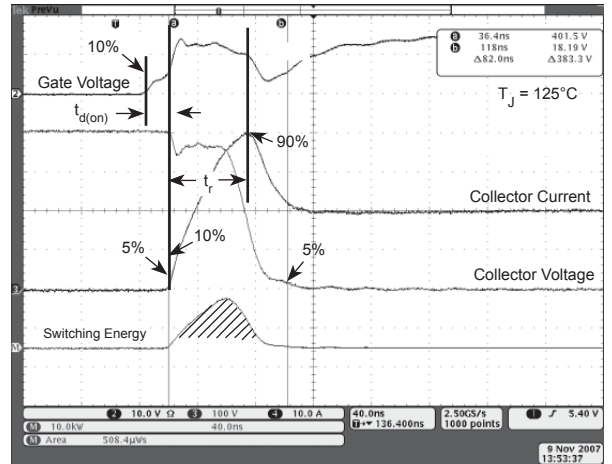


Figure 21, Turn-on Switching Waveforms and Definitions

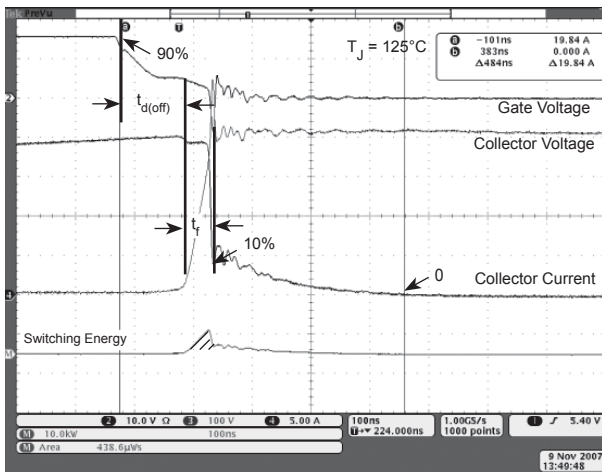
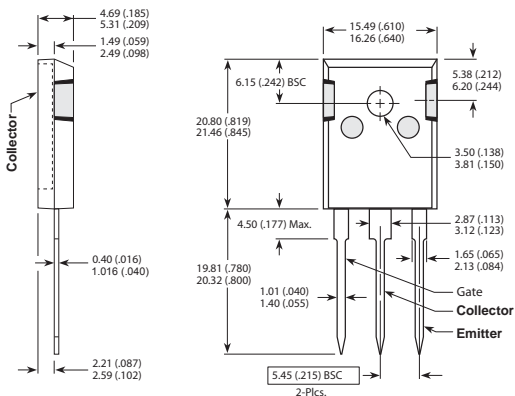


Figure 22, Turn-off Switching Waveforms and Definitions

**TO-247 (B) Package Outline**

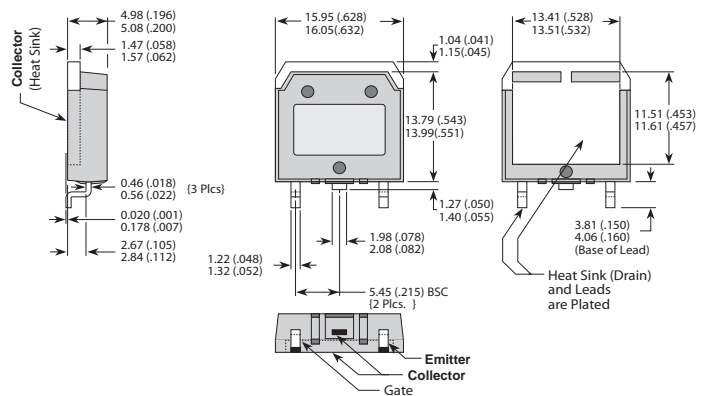
① SAC: Tin, Silver, Copper



Dimensions in Millimeters (Inches)

**D<sup>3</sup>PAK Package Outline**

③ 100% Sn Plated



Dimensions in Millimeters (Inches)



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Электрон  
Связь**

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